

# BIPOLAR ANALOG INTEGRATED CIRCUIT μPC2745TB,μPC2746TB

# **3 V, SUPER MINIMOLD SILICON MMIC** WIDEBAND AMPLIFIER FOR MOBILE COMMUNICATIONS

## DESCRIPTION

The  $\mu$ PC2745TB and  $\mu$ PC2746TB are silicon monolithic integrated circuits designed as buffer amplifier for mobile communications. These low current amplifiers operate on 3.0 V (1.8 V MIN.).

These ICs are manufactured using our 20 GHz fr NESATIII silicon bipolar process. This process uses silicon nitride passivation film and gold electrodes. These materials can protect chip surface from external pollution and prevent corrosion/migration. Thus, these IC have excellent performance, uniformity and reliability.

#### FEATURES

| • | Supply voltage                  | : | Recommended Vcc = 2.7 to 3.3 V                                  |
|---|---------------------------------|---|---|
|   |                                 |   | Circuit operation $Vcc = 1.8$ to 3.3 V                          |
| • | Upper limit operating frequency | : | $\mu$ PC2745TB; fu = 2.7 GHz TYP.@3 dB bandwidth                |
|   |                                 |   | $\mu$ PC2746TB; fu = 1.5 GHz TYP.@3 dB bandwidth                |
| • | High isolation                  | : | μPC2745TB; ISL = 38 dB TYP.@f = 500 MHz                         |
|   |                                 |   | μPC2746TB; ISL = 45 dB TYP.@f = 500 MHz                         |
| • | Power gain                      | : | μPC2745TB; G <sub>P</sub> = 12 dB TYP.@f = 500 MHz              |
|   |                                 |   | μPC2746TB; G <sub>P</sub> = 19 dB TYP.@f = 500 MHz              |
| • | Saturated output power          | : | μPC2745TB; Po <sub>(sat)</sub> = -1 dBm TYP.@f = 500 MHz        |
|   |                                 |   | μPC2746TB; Po <sub>(sat)</sub> = 0 dBm TYP.@f = 500 MHz         |
| • | High-density surface mounting   | : | 6-pin super minimold package ( $2.0 \times 1.25 \times 0.9$ mm) |

## APPLICATIONS

- 1.5 GHz to 2.5 GHz communication system : μPC2745TB
- 800 MHz to 900 MHz communication system : μPC2746TB

## ORDERING INFORMATION

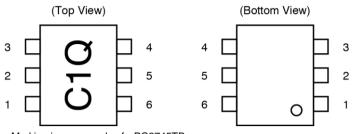
| Part Number    | Package              | Marking | Supplying Form   |
|----------------|----------------------|---------|--|
| μPC2745TB-E3-A | 6-pin super minimold | C1Q     | Embossed tape 8 mm wide  |
| μPC2746TB-E3-A |                      | C1R     | <ul><li>1, 2, 3 pins face the perforation side of the tape</li><li>Qty 3 kpcs/reel</li></ul> |

**Remark**To order evaluation samples, contact your nearby sales office.Part number for sample order:  $\mu$ PC2745TB-A,  $\mu$ PC2746TB-A

#### Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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## **PIN CONNECTION**



| Pin No. | Pin Name |
|---------|----------|
| 1       | INPUT    |
| 2       | GND      |
| 3       | GND      |
| 4       | OUTPUT   |
| 5       | GND      |
| 6       | Vcc      |

#### Marking is an example of $\mu$ PC2745TB

## PRODUCT LINE-UP (TA = +25°C, Vcc = 3.0 V, Zs = ZL = 50 $\Omega$ )

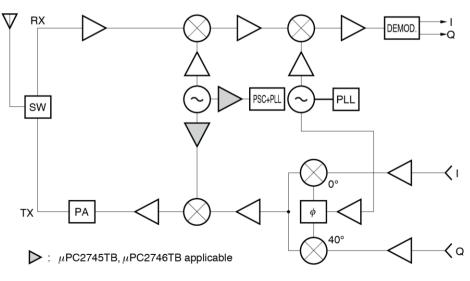
| Part No.  | f <sub>u</sub><br>(GHz) | P <sub>O(sat)</sub><br>(dBm) | G₽<br>(dB) | NF<br>(dB) | lcc<br>(mA) | Package              | Making |
|-----------|-------------------------|------------------------------|------------|------------|-------------|----------------------|--------|
| μPC2745T  | 2.7                     | -1.0                         | 12         | 6.0        | 7.5         | 6-pin minimold       | C1Q    |
| μPC2745TB |                         |                              |            |            |             | 6-pin super minimold |        |
| μPC2746T  | 1.5                     | 0                            | 19         | 4.0        | 7.5         | 6-pin minimold       | C1R    |
| μPC2746TB |                         |                              |            |            |             | 6-pin super minimold |        |
| μPC2747T  | 1.8                     | -7.0                         | 12         | 3.3        | 5.0         | 6-pin minimold       | C1S    |
| μPC2747TB |                         |                              |            |            |             | 6-pin super minimold |        |
| μPC2748T  | 0.2 to 1.5              | -3.5                         | 19         | 2.8        | 6.0         | 6-pin minimold       | C1T    |
| μPC2748TB |                         |                              |            |            |             | 6-pin super minimold |        |
| μPC2749T  | 2.9                     | -6.0                         | 16         | 4.0        | 6.0         | 6-pin minimold       | C1U    |
| μPC2749TB |                         |                              |            |            |             | 6-pin super minimold |        |

Remark Typical performance. Please refer to ELECTRICAL CHARACTERISTICS in detail.

Caution The package size distinguish between minimold and super minimold.

## SYSTEM APPLICATION EXAMPLE

#### DIGITAL CELLULAR SYSTEM BLOCK DIAGRAM



## PIN EXPLANATION

| Pin<br>No.  | Pin Name | Applied<br>Voltage<br>(V) | Pin<br>Voltage<br>(V) <sup>Note</sup> | Function and Applications  | Internal Equivalent Circuit |
|-------------|----------|---------------------------|---------------------------------------|--|-----------------------------|
| 1           | INPUT    |                           | 0.87<br>0.82                          | Signal input pin. A internal matching circuit, configured with resistors, enables $50 \Omega$ connection over a wide band. this pin must be coupled to signal source with capacitor for DC cut.  | 6                           |
| 2<br>3<br>5 | GND      | 0                         | _                                     | Ground pin. This pin should be connected<br>to system ground with minimum<br>inductance. Ground pattern on the board<br>should be formed as wide as possible. All<br>the ground pins must be connected<br>together with wide ground pattern to<br>decrease impedance difference. |                             |
| 4           | OUTPUT   |                           | 1.95<br>2.54                          | Signal output pin. A internal matching circuit, configured with resistors, enables $50 \Omega$ connection over a wide band. This pin must be coupled to next stage with capacitor for DC cut.  | 3 2 5                       |
| 6           | Vcc      | 2.7 to<br>3.3             |                                       | Power supply pin. This pin should be<br>externally equipped with bypass capacity to<br>minimize ground impedance.  |                             |

**Note** Pin voltage is measured at V<sub>cc</sub> = 3.0 V. Above:  $\mu$ PC2745TB, Below:  $\mu$ PC2746TB

## ABSOLUTE MAXIMUM RATINGS

| Parameter                     | Symbol | Conditions                         | Ratings     | Unit |
|-------------------------------|--------|------------------------------------|-------------|------|
| Supply Voltage                | Vcc    | $T_A = +25^{\circ}C$               | 4.0         | V    |
| Circuit Current               | lcc    | T <sub>A</sub> = +25°C             | 16          | mA   |
| Power Dissipation             | PD     | T <sub>A</sub> = +85°C <b>Note</b> | 270         | mW   |
| Operating Ambient Temperature | TA     |                                    | -40 to +85  | °C   |
| Storage Temperature           | Tstg   |                                    | -55 to +150 | °C   |
| Input Power                   | Pin    | T <sub>A</sub> = +25°C             | 0           | dBm  |

Note Mounted on double-sided copper-clad  $50 \times 50 \times 1.6$  mm epoxy glass PWB

## **RECOMMENDED OPERATING RANGE**

| Parameter      | Symbol | MIN. | TYP. | MAX. | Unit |
|----------------|--------|------|------|------|------|
| Supply Voltage | Vcc    | 2.7  | 3.0  | 3.3  | V    |

#### **ELECTRICAL CHARACTERISTICS**

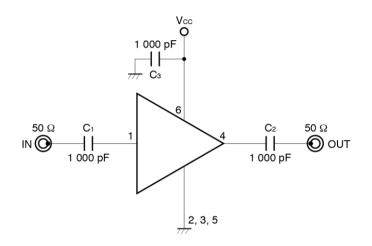
## (TA = +25°C, Vcc = 3.0 V, Zs = ZL = 50 $\Omega$ , unless otherwise specified)

|                                 | Cumbol  | Test Conditions   | μ    | μPC2745TB |      |      | μPC2746TB |      |      |
|---------------------------------|---------|---|------|-----------|------|------|-----------|------|------|
| Parameter                       | Symbol  |   | MIN. | TYP.      | MAX. | MIN. | TYP.      | MAX. | Unit |
| Circuit Current                 | lcc     | No signal   | 5.0  | 7.5       | 10.0 | 5.0  | 7.5       | 10.0 | mA   |
| Power Gain                      | G٩      | f = 500 MHz   | 9    | 12        | 14   | 16   | 19        | 21   | dB   |
| Noise Figure                    | NF      | f = 500 MHz   | _    | 6.0       | 7.5  |      | 4.0       | 5.5  | dB   |
| Upper Limit Operating Frequency | fu      | 3 dB down below<br>from gain at f =<br>0.1 GHz  | 2.3  | 2.7       |      | 1.1  | 1.5       |      | GHz  |
| Isolation                       | ISL     | f = 500 MHz   | 33   | 38        | _    | 40   | 45        | _    | dB   |
| Input Return Loss               | RLin    | f = 500 MHz   | 8    | 11        |      | 10   | 13        |      | dB   |
| Output Return Loss              | RLout   | f = 500 MHz   | 2.5  | 5.5       |      | 5.5  | 8.5       |      | dB   |
| Saturated Output Power          | Po(sat) | $\label{eq:f} \begin{array}{l} f=500 \text{ MHz},\\ P_{\text{in}}=-6 \text{ dBm} \end{array}$ | -4.0 | -1.0      |      | -3.0 | 0         |      | dBm  |

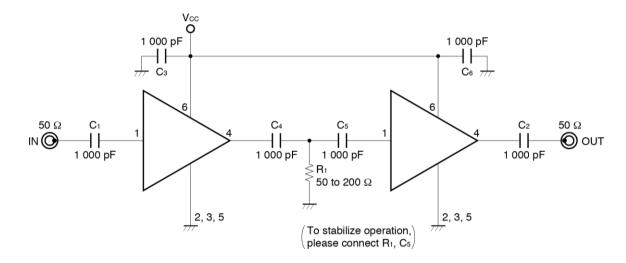
| Parameter                                  | Symbol  | Test Conditions  | Referen                 | ce Value           | Unit |
|--|---------|--|-------------------------|--------------------|------|
|  |         |  | μPC2745TB               | μPC2746TB          |      |
| Circuit Current                            | Icc     | Vcc = 1.8 V, No signal   | 4.5                     | 4.5                | mA   |
| Power Gain                                 | G₽      | Vcc = 3.0 V, f = 1.0 GHz   | 12.0                    | 18.5               | dB   |
|  |         | Vcc = 3.0 V, f = 2.0 GHz<br>Vcc = 1.8 V, f = 0.5 GHz   | 11.0<br>7.0             | <br>14.0           |      |
| Noise Figure                               | NF      | Vcc = 3.0 V, f = 1.0 GHz<br>Vcc = 3.0 V, f = 2.0 GHz<br>Vcc = 1.8 V, f = 0.5 GHz   | 5.5<br>5.7<br>8.0       | 4.2<br>—<br>5.0    | dB   |
| Upper Limit<br>Operating<br>Frequency      | fu      | $V_{CC}$ = 1.8 V, 3 dB down below from gain at f = 0.1 GHz   | 1.8                     | 1.1                | GHz  |
| Isolation                                  | ISL     | Vcc = 3.0 V, f = 1.0 GHz<br>Vcc = 3.0 V, f = 2.0 GHz<br>Vcc = 1.8 V, f = 0.5 GHz   | 33<br>30<br>35          | 38<br>—<br>37      | dB   |
| Input Return<br>Loss                       | RLin    | Vcc = 3.0 V, f = 1.0 GHz<br>Vcc = 3.0 V, f = 2.0 GHz<br>Vcc = 1.8 V, f = 0.5 GHz   | 13.0<br>14.0<br>6.5     | 10.0<br>—<br>10.0  | dB   |
| Output Return<br>Loss                      | RLout   | Vcc = 3.0 V, f = 1.0 GHz<br>Vcc = 3.0 V, f = 2.0 GHz<br>Vcc = 1.8 V, f = 0.5 GHz   | 6.5<br>8.5<br>6.0       | 8.5<br>—<br>9.5    | dB   |
| Saturated<br>Output Power                  | Po(sat) | $\label{eq:Vcc} \begin{array}{l} V_{cc} = 3.0 \ V, \ f = 1.0 \ GHz, \ P_{in} = -6 \ dBm \\ V_{cc} = 3.0 \ V, \ f = 2.0 \ GHz, \ P_{in} = -6 \ dBm \\ V_{cc} = 1.8 \ V, \ f = 0.5 \ GHz, \ P_{in} = -10 \ dBm \end{array}$  | -2.5<br>-3.5<br>-11.0   | -1.0<br><br>-8.0   | dBm  |
| 3rd Order<br>Intermodulation<br>Distortion | IM3     | $      V_{CC} = 3.0 \text{ V}, \ P_{out} = -10 \ dBm, \ f_1 = 500 \ MHz, \ f_2 = 502 \ MHz \\      V_{CC} = 1.8 \ V, \ P_{out} = -20 \ dBm, \ f_1 = 500 \ MHz, \ f_2 = 502 \ MHz \\      V_{CC} = 3.0 \ V, \ P_{out} = -10 \ dBm, \ f_1 = 1 \ 000 \ MHz, \ f_2 = 1 \ 002 \ MHz $ | -30.0<br>-31.0<br>-26.0 | -26.0<br>-37.0<br> | dBc  |

# STANDARD CHARACTERISTICS FOR REFERENCE (TA = +25°C, Vcc = 3.0 V, Zs = ZL = 50 $\Omega$ )

## **TEST CIRCUIT**



## EXAMPLE OF APPLICATION CIRCUIT



The application circuits and their parameters are for references only and are not intended for use in actual design-ins.

#### CAPACITORS FOR THE Vcc, INPUT, AND OUTPUT PINS

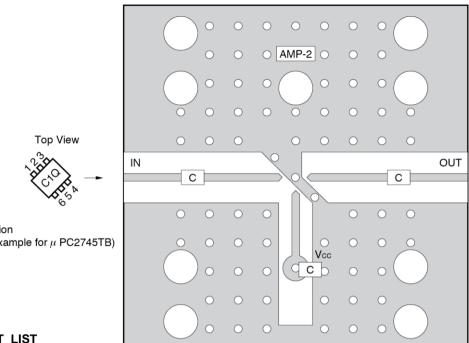
Capacitors of 1 000 pF are recommendable as the bypass capacitor for the Vcc pin and the coupling capacitors for the input and output pins.

The bypass capacitor connected to the Vcc pin is used to minimize ground impedance of Vcc pin. So, stable bias can be supplied against Vcc fluctuation.

The coupling capacitors, connected to the input and output pins, are used to cut the DC and minimize RF serial impedance. Their capacitance are therefore selected as lower impedance against a 50  $\Omega$  load. The capacitors thus perform as high pass filters, suppressing low frequencies to DC.

To obtain a flat gain from 100 MHz upwards, 1 000 pF capacitors are used in the test circuit. In the case of under 10 MHz operation, increase the value of coupling capacitor such as 10 000 pF. Because the coupling capacitors are determined by equation, fc =  $1/(2\pi RC)$ .

## ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



Mounting direction (Marking is an example for  $\mu$  PC2745TB)

#### COMPONENT LIST

|   | Value    |
|---|----------|
| С | 1 000 pF |

#### Notes

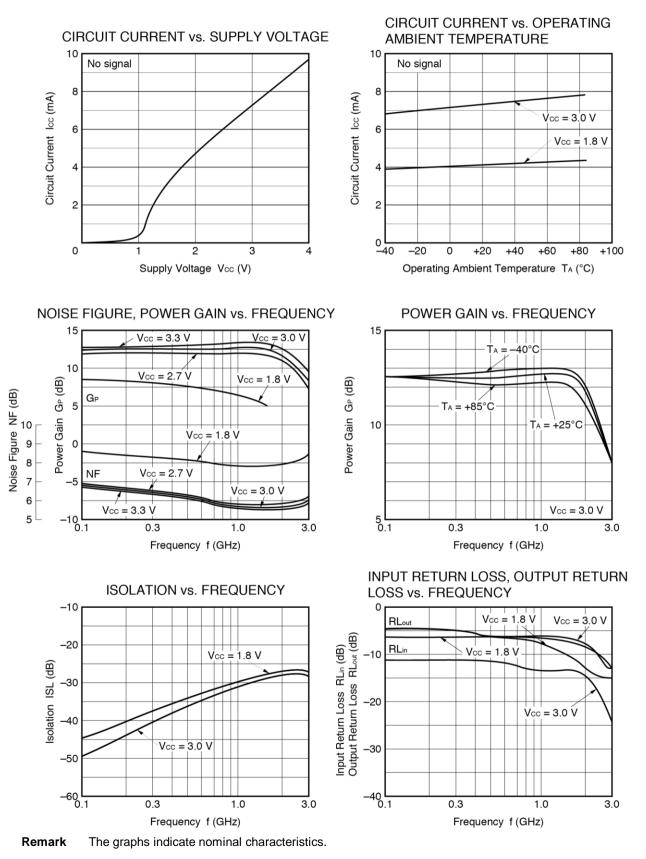
1.  $30 \times 30 \times 0.4$  mm double sided copper clad polyimide board.

- 2. Back side: GND pattern
- 3. Solder plated on pattern
- 4.  $\oplus \bigoplus \bigoplus$ : Through holes

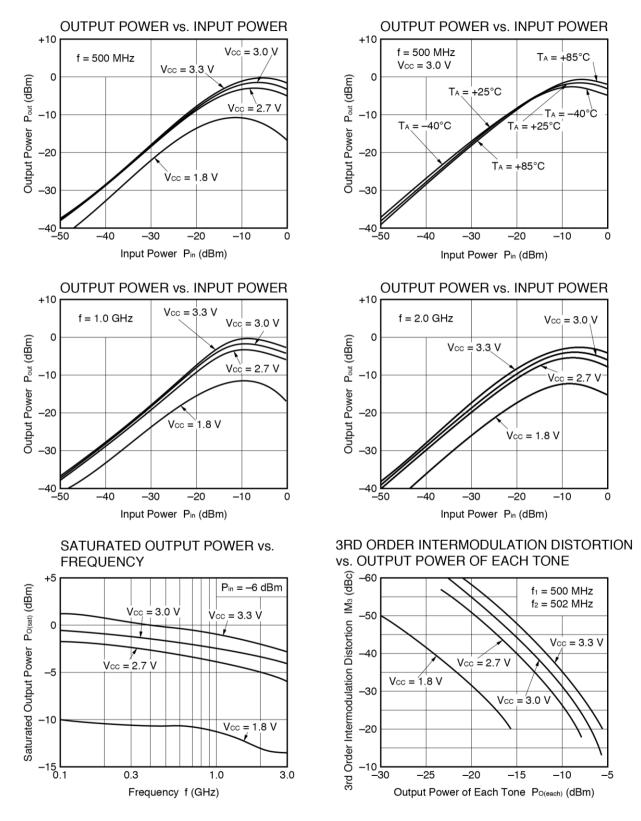
For more information on the use of this IC, refer to the following application note: USAGE AND APPLICATIONS OF 6-PIN MINI-MOLD, 6-PIN SUPER MINI-MOLD SILICON HIGH-FREQUENCY WIDEBAND AMPLIFIER MMIC (P11976E).

## TYPICAL CHARACTERISTICS (T<sub>A</sub> = +25°C, unless otherwise specified)

— μPC2745TB —



— *µ*РС2745ТВ —

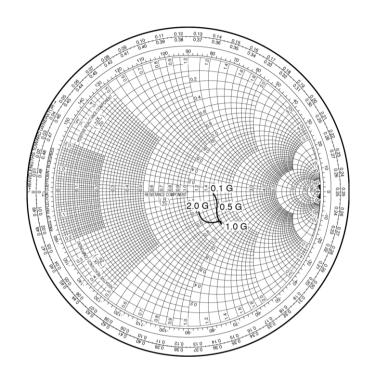


Remark The graphs indicate nominal characteristics.

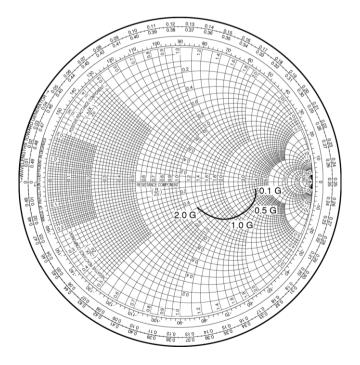
## SMITH CHART (T<sub>A</sub> = +25°C, Vcc = 3.0 V)

— μPC2745TB —

S11-FREQUENCY



S22-FREQUENCY

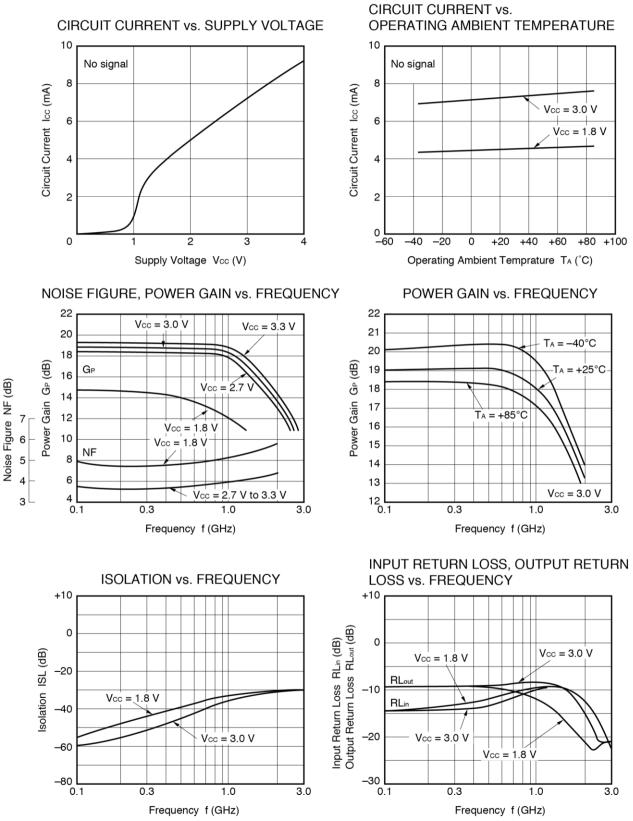


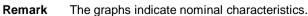
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- S-parameters and noise parameters are provided on our Web site in a format (S2P) that enables the direct import of the parameters to microwave circuit simulators without the need for keyboard inputs.
- Click here to download S-parameters.
- [RF and Microwave] ® [Device Parameters]
- · URL http://www.necel.com/microwave/en/

## **TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)**

#### — μPC2746TB —





-10

ΤA

\_

-10

-5

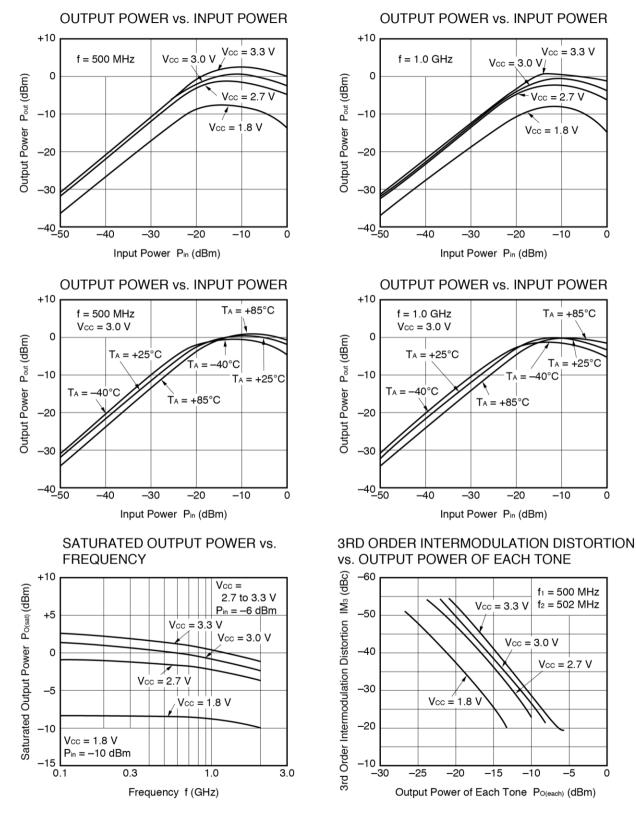
0

0

+25°C

0

#### *— µ*РС2746ТВ —

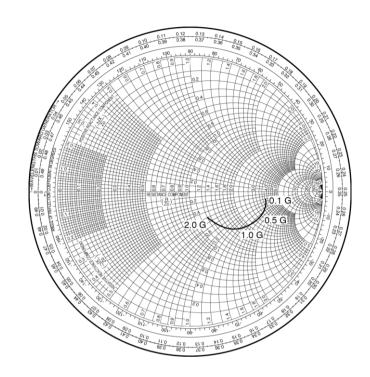


The graphs indicate nominal characteristics. Remark

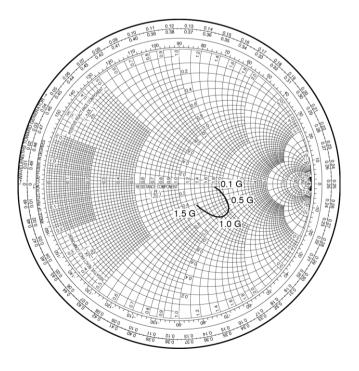
## SMITH CHART (T<sub>A</sub> = +25°C, Vcc = 3.0 V)

— μPC2746TB —

S11-FREQUENCY



S22-FREQUENCY

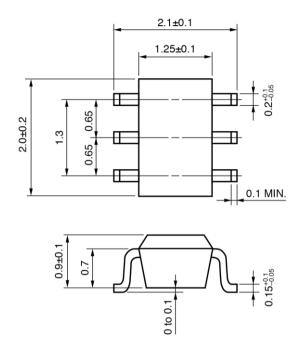


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- Click here to download S-parameters.
- [RF and Microwave] ® [Device Parameters]
- · URL http://www.necel.com/microwave/en/

## PACKAGE DIMENSIONS

# 6-PIN SUPER MINIMOLD (UNIT: mm)



## NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground pins must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to the  $V{\rm cc}$  pin.
- (4) The DC cut capacitor must be attached to input pin and output pin.

## **RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions   | Condition Symbol  |        |
|------------------|--|---|--------|
| Infrared Reflow  | Peak temperature (package surface temperature)<br>Time at peak temperature<br>Time at temperature of 220°C or higher<br>Preheating time at 120 to 180°C<br>Maximum number of reflow processes<br>Maximum chlorine content of rosin flux (% mass) | : 260°C or below<br>: 10 seconds or less<br>: 60 seconds or less<br>: 120±30 seconds<br>: 3 times<br>: 0.2%(Wt.) or below | IR260  |
| VPS              | Peak temperature (package surface temperature)<br>Time at temperature of 200°C or higher<br>Preheating time at 120 to 150°C<br>Maximum number of reflow processes<br>Maximum chlorine content of rosin flux (% mass)                             | : 215°C or below<br>: 25 to 40 seconds<br>: 30 to 60 seconds<br>: 3 times<br>: 0.2%(Wt.) or below                         | VP215  |
| Wave Soldering   | Peak temperature (molten solder temperature)<br>Time at peak temperature<br>Preheating temperature (package surface temperature)<br>Maximum number of flow processes<br>Maximum chlorine content of rosin flux (% mass)                          | : 260°C or below<br>: 10 seconds or less<br>: 120°C or below<br>: 1 time<br>: 0.2%(Wt.) or below                          | WS260  |
| Partial Heating  | Peak temperature (pin temperature)<br>Soldering time (per side of device)<br>Maximum chlorine content of rosin flux (% mass)   | : 350°C or below<br>: 3 seconds or less<br>: 0.2%(Wt.) or below   | H\$350 |

Caution Do not use different soldering methods together (except for partial heating).

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